



Form PTO 1449 (Modified)		U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE		ATTY DOCKET NO. 251148US0		SERIAL NO. 10/809,704	
LIST OF REFERENCES CITED BY APPLICANT				APPLICANT Yuko UCHIMARU, et al.			
				FILING DATE March 26, 2004		GROUP	
U.S. PATENT DOCUMENTS							
EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE
	AA						
	AB						
	AC						
	AD						
	AE						
	AF						
	AG						
	AH						
	AI						
	AJ						
	AK						
	AL						
	AM						
	AN						
FOREIGN PATENT DOCUMENTS							
		DOCUMENT NUMBER	DATE	COUNTRY	TRANSLATION YES NO		
mg	AO	2002-317049	10/31/2002	JAPAN (with English Abstract)			X
	AP	2968244	08/20/1999	JAPAN (with English Abstract)			X
	AQ	3041424	03/10/2000	JAPAN (with translation of claim 1)			X
	AR	2002-359240	12/13/2002	JAPAN (with English Abstract)			X
mg	AS	2003-119289	04/23/2003	JAPAN (with English Abstract)			X
	AT						
	AU						
	AV						
OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, etc.)							
mg	AW	International Technology Roadmap for Semiconductors 2002 Update, 2002 Update Tables, page 75, "TABLE 62A MPU INTERCONNECT TECHNOLOGY REQUIREMENTS—NEAR-TERM", 2002					
mg	AX	S. SHINMIYAHARA, et al., Cu-Interconnect Technology, page 227, "LATEST DEVELOPMENT OF CU WIRING TECHNIQUES", (with partial English translation)					
	AY						
	AZ					<input type="checkbox"/> Additional References sheet(s) attached	
Examiner <i>Michelle J. ...</i>					Date Considered 6/14/07		
*Examiner: Initial if reference is considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.							